

# MOSFET – Power, Complementary Dual ECH8

60 V, 4.7 A, 55 m $\Omega$  -60 V, -3.5 A, 94 m $\Omega$ 

# **ECH8690**

#### **Description**

This Power MOSFET is Produced Using onsemi's Trench Technology, Which is Specifically Designed to Low on Resistance. This devices is suitable for applications with low on resistance requirements.

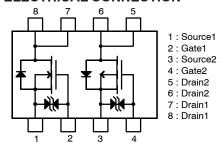
#### **Features**

- On-State Resistance
  - Nch: $R_{DS(on)} 1 = 42 \text{ m}\Omega \text{ (typ.)}$
  - Pch: $R_{DS(on)} 1 = 73 \text{ m}\Omega \text{ (typ.)}$
- Protection Diode In
- 4 V rive
- Nch + Pch MOSFET
- This Device is Pb-Free, Halogen Free and RoHS Compliant



SOT-28FL/ECH8 CASE 318BF

# **ELECTRICAL CONNECTION**



#### **MARKING DIAGRAM**



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

# ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Symbol	Parameter	Conditions	N-Channel	P-Channel	Unit
V <sub>DSS</sub>	Drain to Source Voltage		60	-60	V
V <sub>GSS</sub>	Gate to Source Voltage		±20	±20	V
I <sub>D</sub>	Drain Current (DC)		4.7	-3.5	Α
I <sub>DP</sub>	Drain Current (Pulse)	PW ≤ 10 μs, duty cycle ≤ 1%	30	-30	Α
P <sub>D</sub>	Allowable Power Dissipation	When mounted on ceramic substrate (1200 mm <sup>2</sup> X 0.8 mm) 1 unit	1.5		W
P <sub>T</sub>	Total Dissipation	When mounted on ceramic substrate (1200 mm <sup>2</sup> X 0.8 mm)	1.8		W
Tch	Channel Temperature		150		°C
Tstg	Storage Temperature		-55 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C) (Note 3)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
[N-channe	<u>.                                    </u>	-	-	-	•	-
V <sub>(BR)DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	60	_	-	V
I <sub>DSS</sub>	Zero-Gate Voltage Drain Current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V		-	±10	μΑ
V <sub>GS(off)</sub>	Cutoff Voltage	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.2	-	2.6	V
yfs	Forward Transfer Admittance	V <sub>DS</sub> =10 V, I <sub>D</sub> = 2 A	-	4.2	-	S
R <sub>DS(on)1</sub>	Static Drain to Source	I <sub>D</sub> = 2 A, V <sub>GS</sub> = 10 V	-	42	55	mΩ
R <sub>DS(on)2</sub>	On-State Resistance	I <sub>D</sub> = 1 A, V <sub>GS</sub> = 4.5 V	-	53	74	mΩ
R <sub>DS(on)3</sub>	1	I <sub>D</sub> = 1 A, V <sub>GS</sub> = 4 V	-	61	85	mΩ
Ciss	Input Capacitance	V <sub>DS</sub> = 20 V, f = 1 MHz	-	955	-	pF
Coss	Output Capacitance	7	-	58	-	pF
Crss	Reverse Transfer Capacitance		-	45	-	pF
t <sub>d(on)</sub>	Turn-ON Delay Time	See specified Test Circuit.	-	7	-	ns
t <sub>r</sub>	Rise Time		-	8.4	-	ns
t <sub>d(off)</sub>	Turn-OFF Delay Time		-	76	-	ns
t <sub>f</sub>	Fall Time	7	-	23	_	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.7 A	-	18	-	nC
Qgs	Gate to Source Charge	7	-	3	-	nC
Qgd	Gate to Drain "Miller" Charge	7	-	2.8	-	пC
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> = 4.7 A, V <sub>GS</sub> = 0 V	-	0.82	1.2	V
[P-channe	<u>.                                    </u>	•	•	-	•	
V <sub>(BR)DSS</sub>	Drain to Source Breakdown Voltage	$I_D = -1$ mA, $V_{GS} = 0$ V	-60	_	-	V
I <sub>DSS</sub>	Zero-Gate Voltage Drain Current	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V	-	_	-1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V		_	±10	μΑ
V <sub>GS(off)</sub>	Cutoff Voltage	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-1.2	-	-2.6	V
yfs	Forward Transfer Admittance	$V_{DS} = -10 \text{ V}, I_D = -1.5 \text{ A}$	-	3.4	-	S
R <sub>DS(on)1</sub>	Static Drain to Source	$I_D = -1 \text{ A}, V_{GS} = -10 \text{ V}$	-	73	94	mΩ
R <sub>DS(on)2</sub>	On-State Resistance	$I_D = -0.5 \text{ A}, V_{GS} = -4.5 \text{ V}$	-	97	135	mΩ
R <sub>DS(on)3</sub>	1	I <sub>D</sub> = -0.5 A, V <sub>GS</sub> = 4 V	-	108	153	mΩ

# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C) (Note 3) (continued)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
[P-channe	[P-channel]								
Ciss	Input Capacitance	V <sub>DS</sub> = -20 V, f = 1 MHz	-	790	_	pF			
Coss	Output Capacitance		-	63	_	pF			
Crss	Reverse Transfer Capacitance		-	45	_	pF			
t <sub>d(on)</sub>	Turn-ON Delay Time	See specified Test Circuit.	-	10	_	ns			
t <sub>r</sub>	Rise Time		-	8.8	_	ns			
t <sub>d(off)</sub>	Turn-OFF Delay Time		-	84	_	ns			
t <sub>f</sub>	Fall Time		-	29	_	ns			
Qg	Total Gate Charge	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.5 \text{ A}$	-	15	_	nC			
Qgs	Gate to Source Charge		-	2.6	-	nC			
Qgd	Gate to Drain "Miller" Charge		-	2.2	_	nC			
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> = -3.5 A, V <sub>GS</sub> = 0 V	-	-0.83	-1.2	V			

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

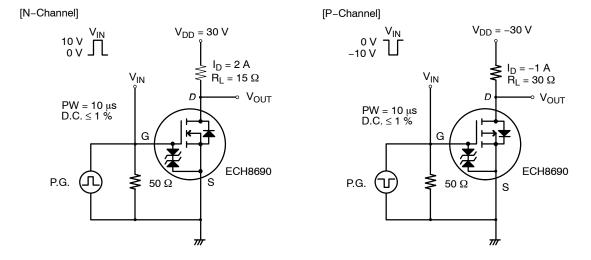
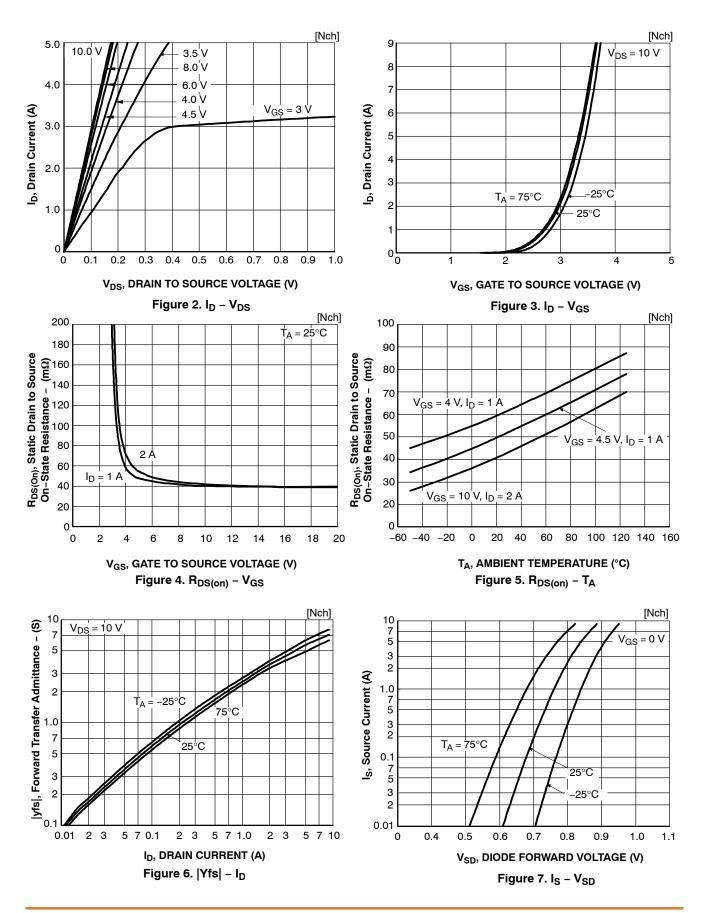
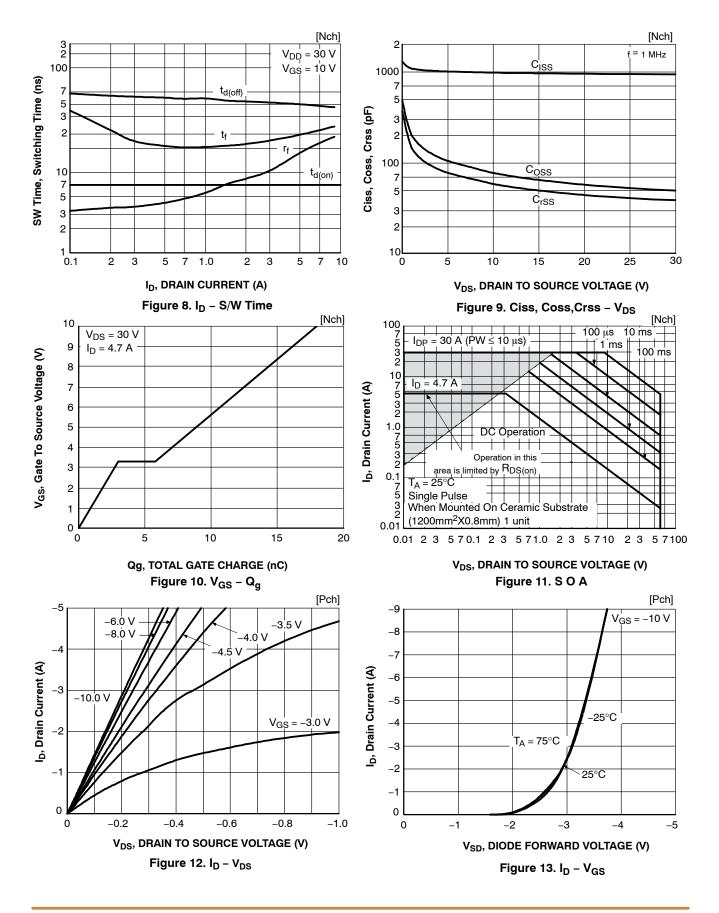


Figure 1. Switching Time Test Circuit

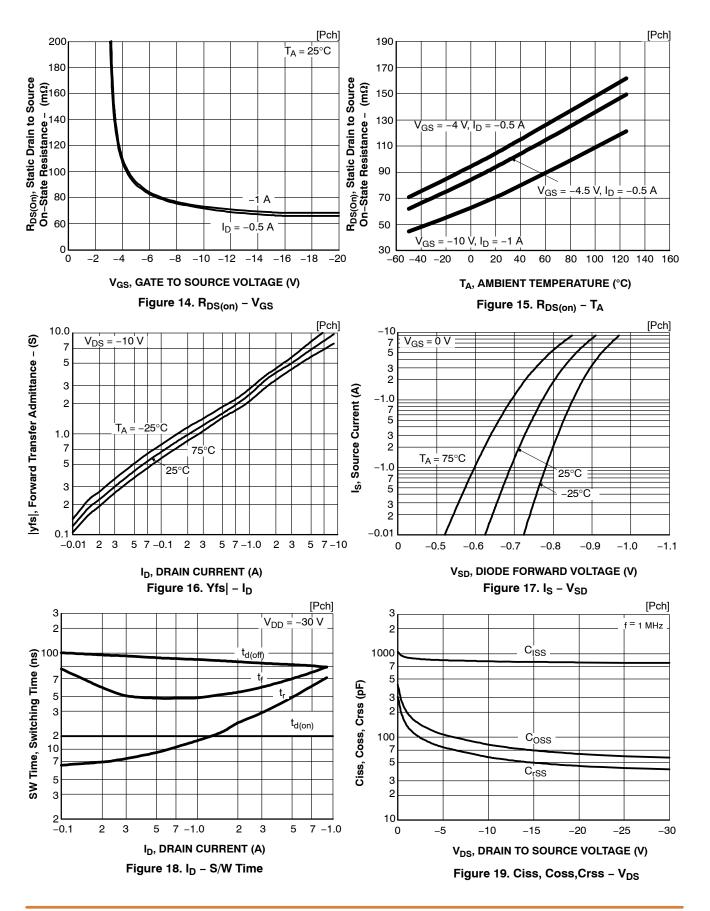
#### **TYPICAL CHARACTERISTICS**



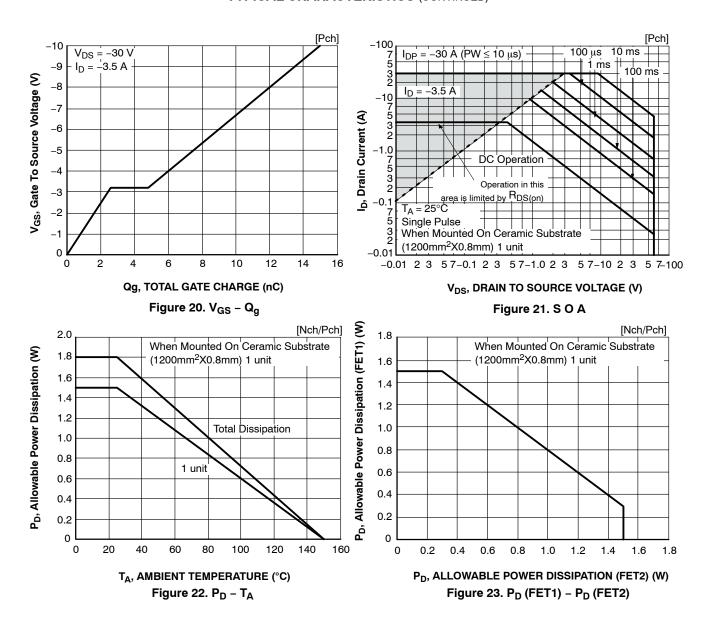
#### TYPICAL CHARACTERISTICS (CONTINUED)



# TYPICAL CHARACTERISTICS (CONTINUED)



# TYPICAL CHARACTERISTICS (CONTINUED)



#### **ORDERING INFORMATION**

Product Number	Package	Shipping <sup>†</sup>
ECH8690-TL-H	SOT-28FL / ECH8 (Pb-Free / Halogen Free)	3000 / Tape and Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

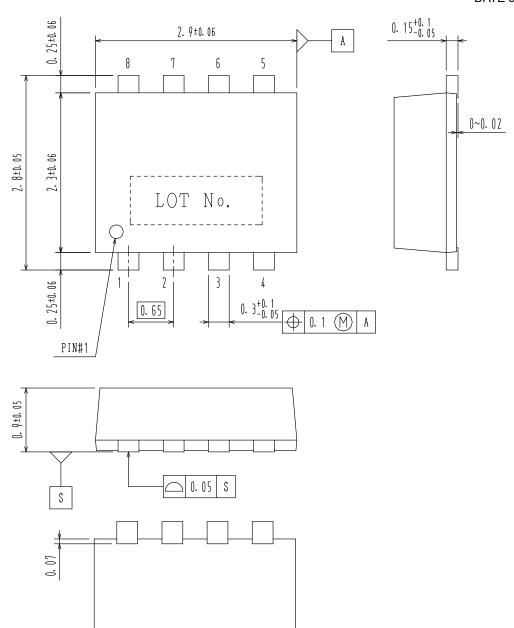
Note on usage: Since the ECH8690 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.





#### SOT-28FL / ECH8 CASE 318BF ISSUE O

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